

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 7,198,969 B1
APPLICATION NO. : 09/656690
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INVENTOR(S) : Igor Y. Khandros and Thomas H. DiStefano

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the title page item (75) Inventors, "Distefano" should read -- DiStefano --.
Column 2, line 7, "between chips" should read -- between chips, --.
Column 3, line 64, "overly one" should read -- overlie one --.
Column 4, line 27, "provides method" should read -- provides a method --.
Column 5, line 67, "overly only" should read -- overlie only --.
Column 7, line 12, "overly the" should read -- overlie the --.
Column 8, line 32, "may be made" should read -- may be made, --.
Column 8, line 33, "instance by wire" should read -- instance, by wire --.
Column 8, line 67, "made for example" should read -- made, for example, --.
Column 11, line 50, "interposer may" should read -- interposer may be --.
Column 13, line 31, "overly the" should read -- overlie the --.
Column 17, line 6, "Alternatively," should read -- Alternatively, as --.
Column 18, line 12, "constitute a" should read -- constitute an --.
Column 22, line 15, "arrangement, includes" should read -- arrangement includes --.
Column 26, line 29, "motion of is middle" should read -- motion of middle --.
Column 28, line 32, "flap extends" should read -- flap extend --.
Column 28, line 63, "and may be" should read -- may be --.
Column 31, line 3, "count" should read -- count, --.
Column 35, line 65, "interpose using" should read -- interposer using --.
Column 38, line 30, "interpose using" should read -- interposer using --.

Signed and Sealed this
Twentieth Day of May, 2008



JON W. DUDAS
Director of the United States Patent and Trademark Office